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Form (Rev. 2/01)

**UNITED STATES** 

Docket No.:

## COMBINED DECLARATION/POWER OF ATTORNEY FOR UTILITY/DESIGN PATENT APPLICATION

As a below named inventor, I hereby declare My residence, post office address and citize I believe that I am the original, first and sole listed below) of the subject matter which is containing foam containing	nship are as stated below next inventor (if only one name is lis laimed and for which a patent i	sted below) or an original, first and joint invento s sought on the invention entitled:	r (if plural names are - the
specification of which is attached hereto, un	less the following box is checke		•
amended on (if applicable).	•••	ve-identified specification, including the claims,	
amendment referred to above. I acknowledge the duty to disclose informati			, ,
I hereby claim foreign priority benefit(s) unde	r 35 U.S.C. 1119(a)-(d) or 136	55(a)-(c) of any foreign application(s) for patent of the transfer of the tran	
Prior Foreign Application(s)			Priority NOT Claimed
2003-106807	Japan	10/April/2003	
(Number)	(Country)	Day/Month/Year Filed	Ų.
2002 162252	lonon	6/ lune/2002	П
2003-162252 (Number)	Japan (Country)	6/June/2003 Day/Month/Year Filed	Ш
,	, ,,	•	_
2003-162253 (Number)	Japan (Country)	6/June/2003 Day/Month/Year Filed	
application and the national or PCT Internat  (Application Serial No.)		R. ' 1.56 which became available between the on.  (Status – patented, pending, a	
(Application Serial No.)	(Filing Date)	(Status patented, pending, a	abandoned)
I hereby appoint the attorneys and agents of all business in the Patent and Trademark O		TO Customer No. 21,171 to prosecute this appl	ication and to transact
21171 PATENT TRADEMARK OFFICE			
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.			
Full name of sole or first inventorMasa	hiro SASAGAWA		
Inventor's Signature	Sasagawa	Date August 19, 2005 Citizenship Japanese	
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Inventor's Signature	Shiraki	Date Rugust 29, 20	ras-
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Additional inventors are being named on separately numbered sheets attached hereto.

## COMBINED DECLARATION/POWER OF ATTORNEY FOR UTILITY/DESIGN PATENT APPLICATION Full name of third inventor \_\_\_\_\_\_\_ Chong-Sun YOO

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Tull hame of multiliventor				
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Inventor's Signature	Date			
Residence				
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Full name of eighth inventor				
Inventor's Signature	Date			
Residence				
Mailing Address				
Full name of ninth inventor				
Inventor's Signature	Date			
Residence				
Mailing Address				

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